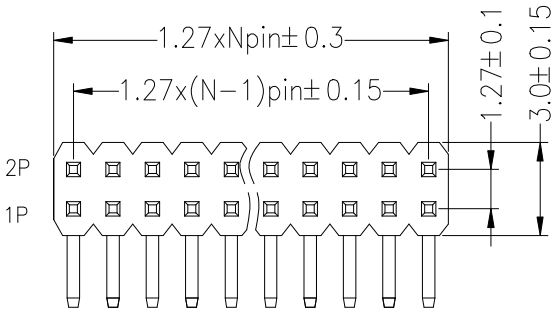
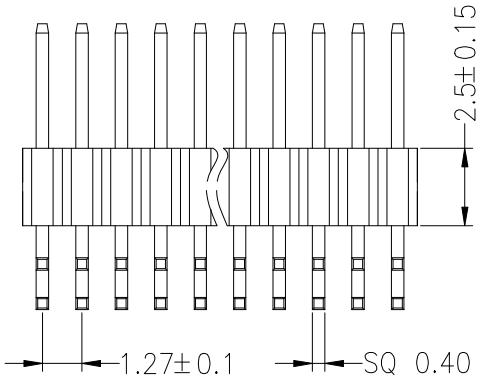
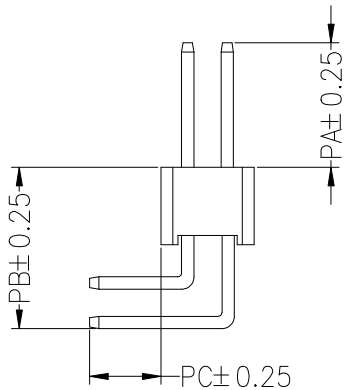
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Soldering temperature:260°C±5° 5S



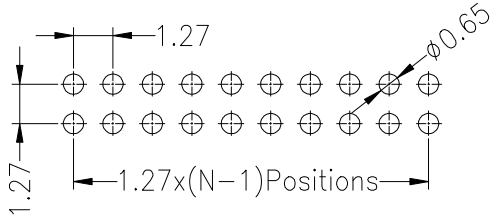




Ordering Information

1425 12 XX X N XX R XXX X 0X

- No.of Pins Per Row: 2−50
- Insulator Material Option: C=BK−PA6T; E=BK−PA9T; F=BK−LCP
- Contact Plating: G1:Gold Flash; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; G6:10U" Gold; G7:15U" Gold; S0:Gold Flash/Tin; SN:Tin
- Pin Length
- Packing: A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

Dimension antitheses list			
ITEM	PA	PB	PC
Alternate	4.00	5.20	2.30

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2022.05.04	NEW DRAWING	

OPERATION		DRAW	Liu Miao	22.05.04
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	142512XXXNXXRXXXX0X
TITLE:	1.27PH H2.5mm 2xNpin 90°